Product name:	Product code:
Through Hole Plating Line for PCB	CMI-NP-1832



Description

Through Hole Plating Line for PCB is a multi-tank line for desmear, conditioning, activation and electroless copper deposition of drilled holes.

Technical specification

Heater	PTFE or titanium, with controller

Standard Accessories

- Anodes
- Racks
- Chemical kit

The Through Hole Plating Line for PCB is a multi-tank line for desmear, conditioning, activation and electroless copper deposition of drilled holes. It is designed for through-hole plating and chemical metallization of double sided and multilayer PCBs in a lab.

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Features

- Complete small-scale hole plating process
- Heated and agitated tanks for uniform plating
- Corrosion-resistant PP or PVC construction
- Digital temperature and timer controls

Technical Specifications

Tanks	6 nos, 10 L each
Temperature	Ambient to 70 deg C
Board size	Up to 250 x 300 mm
Supply	230 V AC, 50 Hz, single phase
Tank material	Polypropylene